

L Number	Hits	Search Text	DB	Time stamp
1	5464	257/239,261,298,315-326.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 09:59
2	4654	438/201,211,216,241,257,258,260-266,591,593.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 09:59
3	9405	257/239,261,298,315-326.ccls. or 438/201,211,216,241,257,258,260-266,591,593.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 09:59
4	3	(257/239,261,298,315-326.ccls. or 438/201,211,216,241,257,258,260-266,591,593.ccls.) and (mask near5 (top near surface) near5 (interlayer near (insulat\$3 oxide dielectric)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 10:09
5	197	(257/239,261,298,315-326.ccls. or 438/201,211,216,241,257,258,260-266,591,593.ccls.) and ((stack\$3 near (structure configur\$5)) with (float\$3 adj gate\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 11:03
6	160	((257/239,261,298,315-326.ccls. or 438/201,211,216,241,257,258,260-266,591,593.ccls.) and ((stack\$3 near (structure configur\$5)) with (float\$3 adj gate\$1))) and mask	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 11:06
7	126	((257/239,261,298,315-326.ccls. or 438/201,211,216,241,257,258,260-266,591,593.ccls.) and ((stack\$3 near (structure configur\$5)) with (float\$3 adj gate\$1))) and mask) and (open\$3 hole\$1 recess\$2 groove trench)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 11:04
8	5	("5225698" "5741735" "5834807" "6534817" "6628544" "2002/0074592" "2002/0153546" "2002/0175394" "2003/0031068" "2003/0068859" "2003/0122181" "2003/0143790").PN.	USPAT	2004/09/27 10:31
9	411405	257/.ccls. 438/.ccls. 365/.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 10:57
10	835	(257/.ccls. 438/.ccls. 365/.ccls.) and ((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 11:57
11	153	((257/.ccls. 438/.ccls. 365/.ccls.) and ((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1))) and ((open\$3 hole\$1 recess\$2 groove trench) near5 ((interlayer insulat\$3) near (film layer)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 12:01
12	138	(((257/.ccls. 438/.ccls. 365/.ccls.) and ((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1))) and ((open\$3 hole\$1 recess\$2 groove trench) near5 ((interlayer insulat\$3) near (film layer)))) and mask	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 11:06
13	24	(((257/.ccls. 438/.ccls. 365/.ccls.) and ((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1))) and ((sidewall (side near wall) near (interlayer insulat\$3) near (film layer)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 11:28

14	46	((257/.ccls. 438/.ccls. 365/.ccls.) and ((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1))) and ((sidewall (side near wall)) near2 (interlayer insulat\$3) near (film layer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 11:31
15	82	((257/.ccls. 438/.ccls. 365/.ccls.) and ((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1))) and ((sidewall (side near wall)) near4 (interlayer insulat\$3) near (film layer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 11:58
16	955	(stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 11:57
17	86	((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1)) and ((sidewall (side near wall)) near4 (interlayer insulat\$3) near (film layer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 12:04
18	26	(((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1)) and ((sidewall (side near wall)) near4 (interlayer insulat\$3) near (film layer))) and ((open\$3 hole\$1 recess\$2 groove trench) near2 ((interlayer insulat\$3) near (film layer)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 12:02
19	52	(((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1)) and ((sidewall (side near wall)) near4 (interlayer insulat\$3) near (film layer))) and ((open\$3 hole\$1 recess\$2 groove trench) with ((interlayer insulat\$3) near (film layer)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 12:04
20	141	((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1)) and ((sidewall (side near wall)) with (interlayer insulat\$3) near (film layer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 12:04
21	120	(((stack\$3 near2 (structure configur\$5)) with (float\$3 adj gate\$1)) and ((sidewall (side near wall)) with (interlayer insulat\$3) near (film layer))) and (open\$3 hole\$1 recess\$2 groove trench)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 12:04